PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Dong Ha Lee	02/01/2010
Jae Jung Park	02/01/2010
Chung Yun Kang	02/01/2010
Myung Bok Kim	02/01/2010

RECEIVING PARTY DATA

Name:	KOREA BUNDY CO., LTD	
Street Address:	206-1, Sin-ri, Jinwi-myeon	
City:	Pyeongtaek-Si, Gyeonggi-do	
State/Country:	REPUBLIC OF KOREA	
Postal Code:	451-860	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12709548

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	565-0001
NAME OF SUBMITTER:	Daniel H. Sherr

Total Attachments: 3

PATENT REEL: 023967 FRAME: 0258 OF \$40.00 12/09548

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> PATENT REEL: 023967 FRAME: 0259

Docket No.:

565-0001

Application No.:

12/709,548

Filing Date:

02/22/2010

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- Dong Ha Lee residing at 206-1, Sin-ri, Jinwi-myeon, Pyeongtaek-Si, Gyeonggi-do, 451-860, Republic of Korea
- Jae Jung Park residing at 206-1, Sin-ri, Jinwi-myeon, Pyeongtaek-Si, Gyeonggi-do, 451-860, Republic of Korea
- Chung Yun Kang residing at School of Materials Science and Engineering Pusan National University 30san, Jangjeon 2-dong, Geumjeong-gu, Busan
- 4) Myung Bok Kim residing at School of Materials Science and Engineering Pusan National University 30san, Jangjeon 2-dong, Geumjeong-gu, Busan

who have made certain new and useful inventions, hereby sell, assign and transfer unto

KOREA BUNDY CO., LTD

having an address at

206-1, Sin-ri, Jinwi-myeon, Pyeongtaek-Si, Gyeonggi-do, 451-860, Republic of Korea

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its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

FILLER METAL ALLOY COMPOSITIONS

for which an application for a United States Patent was filed on 02/22/2010, identified as U.S. Patent Serial Number 12/709,548,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and/or that claim priority thereto and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof and/or that claim priority thereto, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, and associated foreign patent applications, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

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AND the undersigned hereby grants the firm of SHERR & VAUGHN, PLLC the power to insert on this assignment any further identification that may be necessary or desirable in order to comply with the rules of any issuing authority, including the United States Patent and Trademark Office, for recordation of this document.

SIGNED on the dates indicated aside our signatures:

INVENTOR	DATE
	2010/2/1
Dong Ha Lee	
- Park JJ	2010.2.1
Jae Jung Park	
Land	2010,02.0
Chung Yun Kang	
from M/2	2010.2.
Myung Bok Kim	